Last updated 2/26/22

These concepts have been greatly simplified

Crystals are characterized with 3d geometric structures (unit cell)



The spheres here represent the approximate extents of the atom, not the nuclei

- Silicon unit cell
 - 2 interpenetrating Face Centered Cubic Cells



2 FCC cells 1 shifted ¼ of the way along the major diagonal



Resulting diamond cubic lattice



Atoms showing 4 nearest neighbor structure

Lattice parameter (edge length) of 0.543 nm Nearest neighbor distance is 0.235 nm.

- Silicon unit cell
 - Corners: 8, 1/8 atoms/unit cell
 - Faces: 6, 1/2 atoms/unit cell
 - Inside: 4 full atoms/unit cell

3 <u>4</u> 8 atoms/unit cell

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Cell volume:

 $(.543 \text{ nm})^3 = 1.6 \times 10^{-22} \text{ cm}^3$

Density of silicon atoms

= (8 atoms) / (cell volume) = 5 x 10²² atoms/cm³

- Silicon unit cell bonding model
 - Si has a half full outer electron shell (4 / 8)
 - Lowest energy state is the Diamond Lattice
 - 4 electrons are shared between 4 nearest neighbors



Atoms showing 4 nearest neighbor structure



Each atom appears to have a full valence band \rightarrow very stable

- Silicon Crystal binding energies
 - The net effect of combining into the crystal structure is that the allowed energy states are modified
 - A group of allowed low energy states is formed
 - Valence Band
 - At OK, all of the electrons are in these bands
 - A group of allowed high energy states is formed
 - Conduction Band
 - At OK, no electrons are in these bands
 - A gap, where no allowed energy states exist is created
 - Bandgap



4 allowed states / atom in each band

6

- Silicon Crystal binding energies
 - As temperature is increased some electrons acquire enough energy to "jump" the bandgap and move from a valence band state to a conduction band state
 - These electrons can move freely through the crystal while in the conduction band
 - Once an electron has left the valence band, there is a missing bond (electron) in the structure (Hole)
 - These holes can move freely through the crystal while in the valence band

- Intrinsic carrier density
 - How many electrons have moved from the valence band to the conduction band

$$n_i = BT^{3/2} e^{\frac{-E_g}{2kT}}$$

- B semiconductor specific coefficient
- T temperature in Kelvin
- E_g semiconductor band gap energy in eV
- k Boltzmann's constant (86x10⁻⁶ eV/K)

For Si: $B = 5.23 \times 10^{15} \text{ cm}^{-3} \text{K}^{-3/2}$ $E_g = 1.2 \text{eV}(0\text{K}), 1.1 \text{eV}(300\text{K})$

at 300K (room temp?) \rightarrow n_i = 1.5x10¹⁰/cm³

Intrinsic carrier density

5 x 10²² atoms/cm³

1.5x10¹⁰ electrons/cm³

one in 3.3x10¹² electrons has been elevated 1 in 3 Trillion

resistivity $\rho = 3.4 \times 10^5 \Omega$ -cm

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